Overview

HP EliteBook 645 14 inch G9 Notebook PC



Left

- 1. Internal Microphones (2)
- 2. Webcam LED (Optional)
- **3.** Camera Shutter (Only available with webcam)
- 4. HD TNR and IR Camera (Optional)
- 5. IR Camera LED (Optional)

- 6. Clickpad
- 7. Smartcard Reader (Optional)
- 8. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 9. Ethernet Port (RJ-45)
- **10.** Nano Security Lock Slot (Lock sold separately)

Overview



1. Power Button Key

- 2. Power Connector
- 3. SuperSpeed USB Type-C® 10Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)
- **4.** SuperSpeed USB Type-A 5Gbps signaling rate port (Powered port) (USB 3.2 Gen 1)
- **5.** SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)

Right

- 6. HDMI 2.1 Port (Cable not included)
- 7. Audio Combo Jack
- 8. External SIM Card Slot (Optional)
- 9. Touch Fingerprint Sensor (Select Models)

Overview

AT A GLANCE

- Preinstalled with Windows 11 Pro, other Windows OS or FreeDOS
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 64 GB
- Choice of AMD Barcelo™ 5000 series mobile processors, R7, R5 and R3
- Choice of 35.56 cm (14") diagonal HD, Ultra-Wide Viewing Angle FHD, Touch or Non-Touch screen, and Privacy Panel
 option.
- Features redesigned quiet and responsive HP Keyboard with the HP Programmable key and backlit options
- Choice of solid state drives up to 1 TB
- Multi-layered security with HP SureStart Gen7, HP Privacy Camera, HP Sure View Gen4, HP Wolf Security (Includes HP Sure Sense and HP Sure Click), HP Secure Erase, HP Client Security Manager Gen7 (Includes Sure Run Gen5, Sure Recover Gen5), Touch Fingerprint reader, and Tamper Lock.
- Supports wireless options for connectivity on the go including gigabit-speed Wi-Fi® 6e and CAT9 4G/LTE WWAN
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support HP docking options
- Passed MIL-STD 810H tests
- Battery life up to 20 hours and 30 minutes with the optional 51.3Whr battery
- Optimize your video calls with an HD camera and temporal noise reduction that adjusts to the lighting in your environment.
- 180° synchronized hinge allows the EliteBook to lay completely flat, without lifting the keyboard, and includes everyone with visibility from multiple angles.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



PRODUCT NAME

HP EliteBook 645 14 inch G9 Notebook PC

OPERATING SYSTEM

Preinstalled Windows 11 Pro 1

Windows 11 Pro Education 1

Windows 11 Home - HP recommends Windows 11 Pro for business 1

Windows 11 Home Single Language - HP recommends Windows 11 Pro for business 1

Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing

Agreement) 1

Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade) 1,2

FreeDOS

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply, and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

AMD Ryzen™ 7 PRO 5875U with AMD Radeon™ Graphics (2.00 GHz base clock, up to 4.50 GHz max boost clock, 16 MB L3 cache, 8 cores, 16 threads) ^{3,4,5,6}

AMD Ryzen[™] 7 5825U with AMD Radeon[™] Graphics (2.00 GHz base clock, 16 MB L3 cache, 8 cores, 16 threads) ^{3,4,5,6} AMD Ryzen[™] 5 PRO 5675U with AMD Radeon[™] Graphics (2.30 GHz base clock, up to 4.30 GHz max boost clock, 16 MB L3 cache, 6 cores, 12 threads) ^{3,4,5,6}

AMD Ryzen[™] 5 5625U with AMD Radeon[™] Graphics (2.30 GHz base clock, 16 MB L3 cache, 6 cores, 12 threads) ^{3,4,5,6} AMD Ryzen[™] 3 5425U with AMD Radeon[™] Graphics (2.70 GHz base clock, 8 MB L3 cache, 4 cores, 8 threads) ^{3,4,5,6}

Processor Family

AMD Ryzen™ processor 6

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD 's numbering is not a measurement of clock speed.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. AMD Max Boost frequency performance varies depending on hardware, software and overall system configuration.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.



CHIPSET

Chipset is integrated with processor.

GRAPHICS

Integrated

AMD Radeon Graphics

Supports

Support HD decode, DX12, HDMI 2.1b 7

7. HD content required to view HD images.

DISPLAY

Non-Touch

35.56 cm (14") diagonal FHD UWVA eDP anti-glare Low Blue Light narrow bezel bent, 1000 nits, 100% sRGB for HD + IR camera and WWAN HP Sure View Gen4 integrated privacy screen (1920 x 1080) with HP Eye Ease 8,9,10,11,12

35.56 cm (14") diagonal FHD UWVA eDP anti-glare, low power, bent, 400 nits, 72% NTSC for HD + IR camera and WWAN (1920 \times 1080) 8,9,10

35.6 cm (14") diagonal, FHD UWVA eDP anti-glare narrow bezel bent, 400 nits, 100% sRGB for HD Webcam (1920 x 1080)^{8,9,10} 35.56 cm (14") diagonal FHD UWVA eDP anti-glare narrow bezel bent, 250 nits, 45% NTSC for HD + IR camera and WWAN (1920 x 1080) ^{8,9,10}

35.56 cm (14") diagonal FHD UWVA eDP + W/O PSR anti-glare narrow bezel bent, 250 nits, 45% NTSC for HD + IR camera (1920 x 1080) 8,9,10

35.56 cm (14") diagonal FHD UWVA eDP anti-glare narrow bezel bent, 250 nits,45% NTSC for HD camera and WWAN (1920 x 1080) 8,9,10

35.56 cm (14") diagonal FHD UWVA eDP anti-glare narrow bezel bent, 250 nits,45% NTSC for HD camera (1920 x 1080) 8,9,10

35.6 cm (14") diagonal, FHD UWVA eDP1.4 w/o PSR, anti-glare, 250 nits, 45%, no mic (1920 x 1080) 8,9,10

35.6 cm (14") diagonal, FHD UWVA eDP 1.2 w/o PSR, Anti-Glare, 250 nits, 45% NTSC Narrow Bezel bent (1920 x 1080) 8,9,10

35.56 cm (14") diagonal HD SVA eDP anti-glare narrow bezel bent, 250 nits, 45% NTSC for HD Camera (1366 x 768) 8,9,10

35.6 cm (14") diagonal, HD SVA eDP 1.2 w/o PSR, Anti-Glare, 250 nits, 45% NTSC Narrow Bezel bent (1366 x 768) 8,10,12

Touch

35.56 cm (14") diagonal FHD Anti-Glare UWVA eDP narrow bezel bent touch-on-panel screen, 250 nits, 45% NTSC for HD + IR camera and WWAN (1920 x 1080) 8,9,10,12

35.56 cm (14") diagonal FHD Anti-Glare UWVA eDP narrow bezel bent touch-on-panel screen, 250 nits, 45% NTSC for HD camera (1920 x 1080) 8,9,10,12

Display Size

14" diagonal 35.6 cm (14") diagonal

- 8. HD content required to view HD images.
- 9. Sold separately or as an optional feature.
- 10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 11. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.



Technical Specifications

12. Actual brightness will be lower with touchscreen or HP Sure View.

DOCKING (Sold Separately)

Docking station model #1HP Thunderbolt Dock G2Docking station model #2HP USB-C Dock G5

Docking station model #3 HP USB-C/A Universal Dock G2

For additional aftermarket options and docking specs please see page 41.

STORAGE AND DRIVES

Primary M.2 Storage

128 GB PCIe® NVMe™ M.2 Value Solid State Drive 13

256 GB PCIe® NVMe™ M.2 Value Solid State Drive 13

256 GB PCIe® Gen4x4 NVMe™ M.2 TLC Self Encrypted OPAL2 Solid State Drive 13,14

256 GB PCIe® Gen4x4 NVMe™ M.2 TLC single-sided Solid State Drive 13,14

256 GB PCIe® NVMe™ M.2 SSD 13

512 GB PCIe® Gen4x4 NVMe™ M.2 TLC Self Encrypted OPAL2 Solid State Drive 13,14

512 GB PCle® Gen4x4 NVMe™ M.2 TLC Solid State Drive 13,14

512 GB PCIe® NVMe™ M.2 SSD 13

1 TB PCIe® Gen4x4 NVMe™ M.2 TLC Solid State Drive 13,14

Secondary M.2 Storage (Optional)

128 GB PCIe® NVMe™ M.2 Value Solid State Drive ^{13,15} 256 GB PCIe® NVMe™ M.2 Value Solid State Drive ^{13,15}

- 13. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.
- 14. Only functions at the Gen3x4 capacity with AMD Ryzen Barcelo processor.
- 15. Second storage is only available with non-WWAN base Unit AND Primary M.2 storage.

MEMORY

Maximum Memory

64 GB DDR4-3200 SDRAM 16

Memory

64 GB DDR4-3200 SDRAM (2 x 32 GB) 16

32 GB DDR4-3200 SDRAM (1 x 32 GB) 16

32 GB DDR4-3200 SDRAM (2 x 16 GB) 16

16 GB DDR4-3200 SDRAM (1 x 16 GB) 16

16 GB DDR4-3200 SDRAM (2 x 8 GB) 16

8 GB DDR4-3200 SDRAM (1 \times 8 GB) 16

8 GB DDR4-3200 SDRAM (2 x 4 GB) 16



Memory Slots

2 SODIMM

Both slots are customer accessible / upgradeable DDR4 PC4 SODIMMS (Barcelo runs at 3200) Supports Dual Channel Memory

16. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8852BE 802.11ax 2x2 Wi-Fi® + Bluetooth ® 5.3 Wireless Card ¹⁷
Qualcomm® Fast Connect 6900 Wi-Fi 6E + Bluetooth ® 5.2 (802.11ax 2x2) Wireless Card ¹⁸

WWAN

Intel® XMM™ 7560 R+ LTE-Advanced Pro Cat 16 19

NFC

NXP NPC300 Near Field Communication Module (NFC Mirage WNC XRAV-1)

Miracast

Native Miracast Support

Ethernet

Realtek RTL8111HSH 10/100/1000 Integrated NIC ²⁰ Realtek RTL8111FPH 10/100/1000 Integrated NIC ²⁰

Wake on WLAN

Support on S3 AC mode only

- 17. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs.
- 18. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.
- 19. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.
- 20. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.



AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Integrated microphone (Dual Array)

Speaker Power

2W/4ohm Per speaker

Camera

720p HD camera with Temporal Noise Reduction ^{8,9}
720p HD camera+IR Camera with Temporal Noise Reduction ^{8,9}

- 8. HD content required to view HD images.
- 9. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant with optional backlit function 21

Pointing Device

Clickpad with multi-touch gesture support

Function Keys

- F1 Display Switching
- F2 Blank or SureView On/Off
- F3 Brightness Down
- F4 Brightness Up
- F5 Audio Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Blank or Backlit Toggle
- F10 Insert
- F11 Wireless
- F12 Programmable key

Hidden Function Keys

- Fn+R Break
- Fn+S Sys Rq
- Fn+C Scroll Lock
- 21. Backlit keyboard is an optional feature.



SOFTWARE AND SECURITY

Software

HP Quick Touch

HP Ouick Drop 22

HP PC Hardware Diagnostics Windows

Touchpoint Customizer for Commercial

mvHP

HP Smart Support 23

HP Connection Optimizer

HP Hotkey Support

HP Support Assistant 24

HP Notifications

HP Privacy Settings

Buy Microsoft Office (Sold separately)

Manageability Features

HP Connect for Microsoft Endpoint Manager²⁵

HP Image Assistant Gen5 (download)

HP Manageability Integration Kit (download)²⁶

HP Client Management Script Library (download)

HP Patch Assistant (download)²⁷

HP Driver Packs (download)

HP Client Catalog (download)

NOTE: To enhance brightness, level go to the Intel® Graphics Command Center app, click on System and turn off the Display Power Savings function.

Security Management

HP Wolf Security of Business²⁸ includes:

HP Sure Click 29

HP Sure Sense 30

HP Sure Run Gen5³¹

HP Sure Recover Gen5 32

HP Sure Start Gen7 33

HP Tamper Lock

HP Sure Admin 34

HP Client Security Manager Gen7 35

BIOS

HP BIOSphere Gen6 36

HP Secure Erase 37

Absolute Persistence Module 38

HP DriveLock & Automatic DriveLock

BIOS Update via Network

HP Wake on WLAN

HP Fingerprint Sensor 39

Secured-Core PC Enable 40

TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

Security



Technical Specifications

TPM

Model: Infineon SLB9672VU2.0

Version:15.21 Revision: TPM 2.0

FIPS 140-2 Compliant: Yes

Smartcard Reader

Model number: Alcor AU9560 FIPS 201 Compliant: Yes

IPv6 Support

Yes

FirstNet Certified

No

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes

UEFI version: 2.7 Class: Class 3

- 22. HP Quick Drop requires Internet access and Windows 10 PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.
- 23. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.
- 24. HP Support Assistant requires Windows and Internet Access
- 25. HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.
- 26. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.
- 27. HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center Configuration Manager. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html.
- 28. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.
- Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

 29. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.
- 30. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.
- 31. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.
- 32. HP Sure Recover Gen5 is available on select HP PCs and requires Windows 10 and higher and an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module.
- 33. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher
- 34. HP Sure Admin requires Windows 10 and higher, HP BIOS, HP Manageability Integration Kit from http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.
- 35. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.



- 36. HP BIOSphere Gen6 features may vary depending on the platform and configuration.
- 37. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.
- 38. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.
- 39. Fingerprint Reader is an optional feature that must be configured at purchase.
- 40. Requires an Intel® vPro®, AMD Ryzen™ Pro processor or Qualcomm® processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.



POWER

Power Supply

AC Adapter 45 Watt nPFC Standard USB type C Straight 1.8m 41

AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m 41

AC Adapter 45 Watt Smart nPFC Standard C8 for 2 prong Barrel 4.5mm Right Angle 41

AC Adapter 65 Watt nPFC Slim USB type C Straight 1.8m 41

AC Adapter 65 Watt nPFC Standard USB type C Straight 1.8m 41

AC Adapter 65 Watt Smart nPFC EM Barrel 4.5mm 41

AC Adapter 65 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m 41

Battery

HP Long Life 3-cell, 42.75 Wh Polymer ^{42,43} HP Long Life 3-cell, 51.3 Wh Polymer ^{42,43} Compliant with UL 1642 Standard

Power Cord

3-wire plug - 1m 2-wire plug - 1m

Battery Life

Up to 20 hours and 30 minutes with 51whr battery (HP Long Life 3-Cell, 51 Whr Polymer, UMA graphic, AMD R7, display set to 200 nits, 8G memory, 256 GB SSD)⁴⁴

Up to 17 hours and 30 minutes with 42whr battery (HP Long Life 3-Cell, 42 Whr Polymer, UMA graphic, AMD R7, display set to 200 nits, 8G memory, 256 GB SSD)⁴⁴

Battery Weight

HP Long Life 3-cell - 42.75 Wh Polymer - .40 lb HP Long Life 3-cell - 51.3 Wh Polymer - .45 lb HP Long Life 3-cell - 42.75 Wh Polymer - 181.83 g HP Long Life 3-cell - 51.3 Wh Polymer - 203.56 g

- 41. Availability may vary by country.
- 42. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 43. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.
- 44. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.



WEIGHTS & DIMENSIONS

Product Weight

Starting at 3.03 lb ⁴⁵ Starting at 1.37 kg ⁴⁵

Product Dimensions (W x D x H)

12.67 x 8.42 x 0.78 in 32.19 x 21.39 x 1.99 cm

45. Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

Ports

- 1 SuperSpeed USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)
- 3 SuperSpeed USB Type-A 5Gbps signaling rate Port includes 1 Powered port (USB 3.2 Gen 1)
- 1 AC power
- 1 HDMI 2.1 46
- 1 Headphone/microphone combo jack
- 1 Nano SIM slot for WWAN (optional)
- 1 RJ-45

Expansion Slots

Smart Card Reader (optional)

46. HDMI cable sold separately.



Technical Specifications

SERVICE AND SUPPORT

1-year and 3-year limited warranties and 90 day software limited warranty options depending on country.

Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. 47

47. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

CERTIFICATION AND COMPLIANCE

Energy Efficiency Compliance: ENERGY STAR® certified Energy Efficiency Compliance: EPEAT® 2019 Gold ⁴⁸ Environmental Specifications: Low halogen ⁴⁹ Environmental Specifications: TCO 9.0 Certification

48. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information

49. External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.



SYSTEM UNIT

Nominal Operating Voltage 19V

Average Operating Power 7.52W (Idle)

Integrated graphics Yes (AMD Radeon™ Graphics)

Discrete Graphics N/A

Max Operating Power Discrete < 65W

UMA < 45W

Temperature

Operating 32° to 95° F (0° to 35° C) Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

Random Vibration

Operating 1.043 grams
Non-operating 3.5 grams

Altitude (unpressurized)

Operating -50 to 10,000 ft (-15.24 to 3,048 m)
Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

Planned Industry Standard

Certifications

Regulatory Model Number HSN-Q35C-4

 $\begin{array}{ccc} \text{UL} & & \text{Yes} \\ \text{CSA} & & \text{Yes} \\ \text{FCC Compliance} & & \text{Yes} \\ \text{ENERGY STAR}^{\circledcirc} & & \text{Yes}^{50} \\ \end{array}$

EPEAT® 2019 Gold in United States 51

Yes

ICES Yes Australia / Yes **NZ A-Tick Compliance** Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes GOST Yes Saudi Arabian Compliance (ICCP) Yes **SABS** Yes



UKRSERTCOMPUTER

50. Configurations of the HP EliteBook 645 G9 that are ENERGY STAR® certified are identified as HP EliteBook 645 G9 ENERGY STAR on HP websites and on http://www.energystar.gov.

51. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information.

DISPLAYS

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

14.0 in FHD (1920 x 1080) Anti-Glare UWVA Low Blue Light sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD Panel

 Outline Dimensions (W x H)
 314.612x 185.330 (max)

 Active Area
 309.312 x 173.990 mm (typ)

Weight 230 g
Diagonal Size 14 inch
Thickness 2.2/3.9 (max)
Interface eDP 1.3
Surface Treatment Anti-Glare
No

Touch EnabledNoContrast Ratio1500:1Refresh Rate60 HzBrightness1000 nits

Pixel Resolution 1920 x1080 (FHD)

Format WLED Backlight RGB

Color Gamut Coverage sRGB 100%

Color Depth 8

Viewing Angle UWVA 85/85/85

Low Blue Light Yes
Power Consumption (W, EBL@ NA
150nits max/ 200nits max)

Panel LCD 14 inch FHD (1920 x 1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR bent Touch on Panel NWBZ

 Outline Dimensions (W x H)
 316.170 x 186.400 (max)

 Active Area
 309.370 x 174.020 mm (typ)

 Weight
 305 g (max)

 Diagonal Size
 14.0 inch

 Thickness
 3.0 / 5.0 (max)

 Interface
 eDP 1.2

Surface Treatment Anti-Glare On-cell

Touch Enabled

Contrast Ratio

Refresh Rate

Brightness

Yes¹

600:1 (typ)

60 Hz

250 nits¹

Pixel Resolution 1920 x 1080 (FHD)

Format WLED Backlight RGB



Color Gamut Coverage NTSC 45%

Color Depth 6 (Hi FRC w/ condition to enable)

Viewing Angle UWVA 85/85/85

Low Blue Light No

Power Consumption (W, EBL@ 2.30 (max)/ 2.80 (max) 150nits max/ 200nits max)

Panel LCD 14 inch FHD (1920 x 1080) Anti-Glare WLED UWVA sRGB 100percent cg 400nits eDP 1.4+PSR2 bent LP NB2X Outline Dimensions (W x H) 315.070 x 186.600 (max)

 Active Area
 309.370 X 174.020 mm (typ)

 Weight
 200 g (max)

Diagonal Size14.0 inchThickness2.0 /4.0 (max)InterfaceeDP 1.4Surface TreatmentAnti-Glare

Touch Enabled No

Contrast Ratio 1200:1 (typ)
Refresh Rate 60 Hz
Brightness 400 nits

Pixel Resolution 1920 x 1080 (FHD)

Format WLED Backlight RGB

Color Gamut Coverage SRGB 100%

Color Depth 6

Viewing Angle UWVA 85/85/85

Low Blue Light No

Power Consumption (W, EBL@ 2.07 (max)/ 2.50 (max)

150nits max/ 200nits max)

Panel LCD 14-in FHD (1920 x 1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR NWBZ bent

Outline Dimensions (W x H x D) 316.170 x 186.400 (max)

Active Area 309.370 x 174.020 mm (typ)

Weight 300 g (max)
Diagonal Size 14.0 inch
Thickness 3.0 / 5.0 (max)
Interface eDP 1.2
Surface Treatment Anti-Glare

Touch Enabled
Contrast Ratio
Refresh Rate
Brightness
No
600:1 (typ)
60 Hz
250 nits

Pixel Resolution 1920 x 1080 (FHD)

Format WLED

Backlight RGB

Color Gamut Coverage NTSC 45%

Color Depth 6 (Hi FRC w/ condition to enable)

UWVA 85/85/85/85 **Viewing Angle**

Low Blue Light

Power Consumption (W, EBL@ 150nits 2.205 (max)/ 2.716 (max)

max/ 200nits max)

Panel LCD 14-in HD (1366 x 768) Anti-Glare WLED SVA 45percent cg 250nits eDP 1.2 w/o PSR NWBZ bent

Outline Dimensions (W x H x D) 316.110 x 186.370 (max)

309.400 x 173.950 mm (typ) **Active Area**

300 g (max) Weight 14.0 inch **Diagonal Size** 3.0 / 5.0 (max) **Thickness** eDP 1.2 Interface

Anti-Glare **Surface Treatment** No

Touch Enabled 300:1 (typ) **Contrast Ratio** 60 Hz **Refresh Rate** 250 nits

1366 x 768 (HD) **Pixel Resolution**

WLED Format RGB **Backlight NTSC 45% Color Gamut Coverage**

Color Depth

SVA 45/45/15/35 **Viewing Angle**

Low Blue Light Nο

Power Consumption (W, EBL@ 150nits

max/ 200nits max)

Brightness

2.52 (max) / 2.86 (max)



STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

SSD 128GB 2230 PCIe

NVMe Value

Drive WeightM.2 2230Rotation speed128GBNAND TypeTLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Weight 0.01 lb (5 g)
Interface PCIe NVMe Gen3
Maximum Sequential Read Up to 2100 MB/s
Maximum Sequential Write Up to 1200 MB/s
Logical Blocks 250069680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite; TRIM; L1.2

SSD 256GB 2230 PCIe NVMe Value Form Factor M.2 2230
Capacity 256 GB
NAND Type TLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface PCIe NVMe Gen3
Maximum Sequential Read up to 2500 MB/s
Maximum Sequential Write up to 1300 MB/s
Logical Blocks 500118192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite; TRIM; L1.2

SSD 256GB 2280 PCIe NVMe Value Form Factor M.2 2280
Capacity 256GB
NAND Type Value

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3Maximum Sequential ReadUp to 2900 MB/sMaximum Sequential WriteUp to 1400 MB/sLogical Blocks500118192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TRIM; L1.2

SSD 256GB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 256 GB
NAND Type 3D TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

Weight 9.0g

InterfacePCIe NVMe Gen4Maximum Sequential ReadUp to 6,400 MB/sMaximum Sequential WriteUp to 2,700 MB/sLogical Blocks500118192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

256GB PCIe-4x4 2280 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive Form Factor M.2 2280
Capacity 256GB
NAND Type TLC

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen4

Maximum Sequential Read6400Maximum Sequential Write2700Logical Blocks500118192

Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesATA Security (Option); TCG Opal 2.0; TRIM; L1.2

SSD 512GB 2280 PCIe NVMe Value Form Factor M.2 2280
Capacity 512GB
NAND Type Value

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3Maximum Sequential ReadUp to 3500 MB/sMaximum Sequential Writeup to 3000 MB/sLogical Blocks1000215216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 512GB
NAND Type 3D TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

Weight 9.0g

InterfacePCIe NVMe Gen4Maximum Sequential ReadUp to 6,600 MB/sMaximum Sequential WriteUp to 5,100 MB/sLogical Blocks1000215216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

512GB PCIe-4x4 2280 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive Form Factor M.2 2280
Capacity 512GB
NAND Type TLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface PCIe NVMe Gen4
Maximum Sequential Read Up to 6,600 MB/s
Maximum Sequential Write Up to 5,100 MB/s
Logical Blocks 1000215216

Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesATA Security (Option); TCG Opal 2.0; TRIM; L1.2

SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 1TB
NAND Type 3D TLC

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen4Maximum Sequential ReadUp to 7,100 MB/sMaximum Sequential WriteUp to 5,200 MB/sLogical Blocks2000409264

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

NETWORKING/COMMUNICATIONS Oualcomm® Fast Connect Wireless LAN Standards IEEE 802.11a IEEE 802.11b 6900 Wi-Fi 6E + BT5.2 IEEE 802.11q (802.11ax 2x2, AMD AIM-IEEE 802.11n T AME, supporting gigabit IEEE 802.11ac file transfer speeds) IEEE 802.11ax Wireless Card 1 IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11u IEEE 802.11v IEEE 802.11w Wi-Fi certified Interoperability **Frequency Band** •802.11b/g/n/ax 2.402 - 2.482 GHz •802.11a/n/ac/ax 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz 5.925 - 7.125 GHz **Data Rates** •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz &

160MHz)

802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz &

160MHz)

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM, 4096QAM

Security³ •AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification

•IEEE 802.11i

Network Architecture

Models Roaming Wi-Fi Direct in Win10 for peer-to-peer connection.

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points **Output Power²** 2.4GHz (MIMO, typical):

• 802.11b: +18dBm • 802.11q: +16.5dBm

802.11n/ac/ax (HT20/VHT20/HE20): +16dBm
 802.11n/ac/ax (HT40/VHT40/HE40): +12.5dBm

5GHz (MIMO, typical): • 802.11a: +13dBm

802.11n/ac/ax (HT20/VHT20/HE20): +13.5dBm
 802.11n/ac/ax (HT40/VHT40/HE40): +12.5dBm



802.11ac/ax (VHT80/HE80): +11.5dBm

• 802.11ax HE160: +11.5dBm 6GHz LPI mode (MIMO, typical):

• 802.11a: 0dBm

• 802.11ax HE20: +1dBm 802.11ax HE40: +4dBm • 802.11ax HE80: +7dBm • 802.11ax HE160: +7.5dBm

Power Consumption Transmit mode: 3.0 W

•Receive mode: 2.0 W

Idle mode (WLAN associated): 300mW Idle mode (WLAN unassociated): 100mW Modern Connected Standby: 10mW

Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 2.4GHz (SISO):

> 802.11b, 11Mbps: -82dBm maximum 802.11g. 54Mbps: -71dBm maximum • 802.11n, MCS7: -64dBm maximum 802.11ac, MCS9: -52dBm maximum

802.11ax, MCS11(HT40): -49dBm maximum

5GHz (SISO):

 802.11a, 54Mbps: -71dBm maximum • 802.11n, MCS07: -64dBm maximum • 802.11ac, MCS9: -52dBm maximum

802.11ax, MCS11(HE80/HE160): -46dBm maximum

6GHz (SISO):

• 802.11a, 54Mbps: -71dBm maximum • 802.11n, MCS7: -64dBm maximum • 802.11ac, MCS9: -52dBm maximum

802.11ax. MCS11(HE160): -46dBm maximum"

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure.

Two embedded dual band 2.4/5/6 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Weight Type 2230: 3q **Operating Voltage** 3.3 +/ 0.165v

Temperature Operating -10° to 60° C Non-operating -40° to 85° C

> 10% to 60% (non-condensing) Operating

Humidity Non-operating 5% to 95% (non-condensing)"

Altitude 0 to 10,000 ft (3,048 m) Operating

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity N/A

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Card

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2 Compliant

Frequency Band 2402 to 2480 MHz Number of Available Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH) Channels



Data Rates and Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps
Throughput BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class 1.5 Bluetooth device

with a maximum transmit power of + 14 dBm and 10 dBm for BR and EDR.

respectively.

- 1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek RTL8852BE
802.11ax 2x2 Wi-Fi® +
BT5.3 (802.11ax 2x2,
supporting gigabit data
rate) Wireless Card ¹

Wireless LAN Standards

IEEE 802.11a
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11d
IEEE 802.11d
IEEE 802.11t
IEEE 802.11t
IEEE 802.11i
IEEE 802.11r

IEEE 802.11v
Interoperability Wi-Fi certified modules
Frequency Band •802.11b/g/n/ax

2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps802.11ac: max 866.7Mbps802.11ax: max 1201Mbps

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security³ •IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification
•WPA3 certification
•IEEE 802.11i

•WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +18.5dBm minimum

802.11g: +17.5dBm minimum802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ax HE40(2.4GHz): +10dBm minimum
802.11ax HE80(5GHz): +10dBm minimum

Power Consumption •Transmit mode:2.5 W

•Receive mode:2 W

Idle mode (PSP)180 mW(WLAN Associated)
 Idle mode:50 mW(WLAN unassociated)
 Connected Standby/Modern Standby: 10mW

•Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ •802.11b, 1Mbps: -93.5dBm maximum

•802.11b, 11Mbps: -84dBm maximum
•802.11a/g, 6Mbps: -86dBm maximum
•802.11a/g, 54Mbps: -72dBm maximum
•802.11n, MCS07: -67dBm maximum
•802.11n, MCS15: -64dBm maximum
•802.11ac, MCS0: -84dBm maximum
•802.11ac, MCS9: -59dBm maximum
•802.11ax, MCS11(HE40): -57dBm maximum
•802.11ax, MCS11(HE80): -54dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230: 2.8g

2. Type 126: 1.3g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED Off - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)
Channels BLE: 0~39 (2 MHz/CH)

Data Rates andLegacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs. Wi-Fi 6™ is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



Intel® XMM™ 7560 R+ LTE-Advanced Pro¹

Technology/Operating

bands

FDD LTE:

2100 (Band 1), 1900 (Band 2), 1800 (Band 3).

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300

(Band 30), 1700/2100 (Band 66), 600 (band 71).

TDD LTE:

2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200 (Band

46 RX onlv) MHz: HSPA+:

2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

Wireless protocol

standards

3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput

up to 978Mbps: UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou

1561.098 MHz

Maximum data rates LTE: 978 Mbps (Download), 150 Mbps (Upload)

> DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

Maximum output power LTE: 23 dBm in all band except B41

> LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm

Maximum power consumption

LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight

Dimensions (Length x Width x

Thickness)

42 x 30 x 2.3 mm

eSIM Support

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.



NXP NPC300 Near Field Communication

Module

Dimensions (L x W x H) Module 17 mm by 10 mm by 2.0 mm

Chipset NPC300 System interface I2C

NFC RF standards ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support

Reader (PCD-VCD)

Mode(1)

Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K

MIFARE 4K MIFARE DESFire

FeliCa

Card Emulation (PICC- IS

VICC) Mode(1)

Jewel and Topaz cards ISO/IEC 14443 A

ISO/IEC 14443 B and B'

MIFARE FeliCa

Frequency 13.56 MHz

NFC Modes Supported Reader/Writer, Peer-to-Peer **Raw RF Data Rates** 106, 212, 424, 848 kbps

Operating temperature Storage temperature

Storage temperature
Humidity

-20°C to 125°C 10-90% operating

0°C to 70°C

5-95% non-operating 2.97 to 5.5 Volts

Supply Operating

voltage

I/O Voltage 1.8V or 3.3V

Power Consumption

(Booster enable, VBAT = 3.3V, VCC_BOOST = 5V)

Mode Power Consumption, Typical

Polling 7.3 mA

Detected Test Tag 32.9 mA

Type 1

Detected Test Tag 70.7 mA

Type 2

Detected Test Tag 79.2 mA

Type 3

Detected Test Tag 64.9 mA

Type 4

Antenna Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is

external to module.

1. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. LTE not available on all products, in all regions

Realtek RTL8111HSH 10/100/1000 Integrated NIC **Ethernet Features**

10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-

30)

1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

Power Management ACPI compliant – multiple power modes

Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power

consumption

Performance Features TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling Jumbo Frame 9K

Manageability Wake-on-LAN from modern standby or sleep state (Magic Packet and

Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface PCIe + SMBus

NIC Device Driver

Name

Realtek PCIe GBE Ethernet Family Controller

Realtek RTL8111FPH 10/100/1000 Integrated NIC **Ethernet Features**

10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-

30)

1000 Mbit/s operation (1000BASE-T: IEEE 802.3ab: IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

Power Management ACPI compliant – multiple power modes

Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power

consumption

Performance Features TO

TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling Jumbo Frame 9K

Manageability Wake-on-LAN from modern standby or sleep state (Magic Packet and

Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Security & Manageability:

Support DASH 1.2 compliant

Manageability: Interface

PCIe + SMBus

NIC Device Driver

Name

Realtek PCIe GBE Ethernet Family Controller

POWER

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

AC Adapter 45 Watt				
nPFC Standard USB type				
C Straight 1.8m				

nput	Input Efficiency	
Weight	192.5g +/-10%	
Dimensions (H x W x D)	94.0mm x 40.0mm x 26.5mm	

Input Efficiency Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac

> Spec: 5V: 81.5% 9V: 86.7% 12V: 87.41% 15V: 87.8%"

Input frequency range 47 ~ 63Hz

Input AC current Max. 1.4 A at 90 Vac

Output power 5V/15W

> 9V/27W 12V/36W 15V/45W

DC output 5V/9V/12V/15V Hold-up time 5ms at 115 Vac input

Output current limit <5.0A

Connector USB Type-C

Output

32°F to 95°F (0° to 35°C) **Environmental Design** Operating temperature -4°F to 185°F (-20° to 85°C)

Non-operating (storage)

temperature Altitude 0 to 16,400 ft (0 to 5,000m)

Humidity 20% to 95% Storage Humidity 10% to 95%

EMI and Safety

Certifications *CE Mark - full compliance with LVD and EMC directives

> * Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1,

SELV:

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC

Class B, CISPR32 Class B, CCC, NOM-001 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m

Dimensions 95x45x26.5mm Weight unit: 200g +/- 10g

Input **Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230Vac

> 47 ~ 63 Hz Input frequency range

Max. 1.4 A at 90 Vac **Input AC current**

45W Output **Output power**

19.5V DC output

5ms at 115 Vac input Hold-up time

<8.0A **Output current limit**

Connector 4.5mm Barrel Type

Environmental Design Operating temperature 32°F to 95°F (0°to 35°C)

Non-operating (storage)

temperature

-4°F to 185°F (-20°to 85°C)

Altitude 0 to 16.400 ft (0 to 5.000m)

Humidity 20% to 95% Storage Humidity 10% to 95%

EMI and Safety

Certifications *CE Mark - full compliance with LVD and EMC directives

> * Worldwide safety standards - IEC60950-1 and/or IEC62368-1. EN60950-1 and/or EN62368-1. UL60950-1 and/or UL62368-1. Class1.

SELV:

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC

Class B, CISPR32 Class B, CCC, NOM-001 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Standard USB type C Straight 1.8m

Input

Dimensions 90.0 x 51 x 28.5mm Weight unit: 250a +/- 10a

> **Input Efficiency** Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V:81.5% 9V:86.7% 12V:88% 15V:88% 20V:89%

Input frequency

range

1.6 A at 90 VAC and maximum load **Input AC current**

47 ~ 63 Hz

5V/15W 9V/27W 12V/60W 15V/60W

Output Output power 20V/65W

5V/9V/12V/15V/20V DC output 5ms at 115 Vac input Hold-up time

<8.0A **Output current limit**

USB Type C

Connector **Environmental Design Operating**

32°Fto 95°F (0°to 35°C)

-4°Fto 185°F (-20°to 85°C)

Non-operating (storage) temperature

temperature

Altitude 0 to 16,400 ft (0 to 5,000m)

Humidity 20% to 95 Storage Humidity 10% to 95%

88.0 % at 115 Vac and 89.0 % at 230Vac

Technical Specifications

EMI and Safety Certifications

Input

Connector

Eg:

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1,

SELV:

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC

Class B, CISPR32 Class B, CCC, NOM-001 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt Smart nPFC EM Barrel 4.5mm
 Dimensions
 102 x 55 x 30mm

 Weight
 unit: 250g +/- 10g

Input Efficiency Input frequency

uency 47 ~ 63 Hz

range

Input AC current

Max. 1.7 A at 90 Vac

Output Output power 65W

Of output 19.5V

DC output 19.5V

Hold-up time 5ms at 115 Vac input **Output current limit** <11.0A

4.5mm Barrel Type

Environmental Design

Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage)

-4°F to 185°F (-20°to 85°C)

(storage) temperature Altitude

Altitude 0 to 16,400 ft (0 to 5,000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications

Eg:

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1,

SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC

Class B, CISPR32 Class B, CCC, NOM-001 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m Dimensions90 x 51 x 28.5mmWeight230g +/-10%InputInput Efficiency

Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range

47 ~ 63 Hz

Input AC current

Max. 1.7 A at 90 Vac

Outpu Output power 65W

DC output 19.5V

Hold-up time 5 ms at 115 Vac input

Output current limit

<11.0A

Connector

4.5mm Barrel Type

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating -4°F to 185°F (-20°to 85°C)

(storage) temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Eg

Certifications *CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1,

SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC

Class B, CISPR32 Class B, CCC, NOM-001 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Slim USB type C Straight 1.8m

Input

Connector

Environmental Design

 Dimensions
 88x53.5x21mm

 Weight
 unit: 220g +/- 10g

Input Efficiency 81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

Input frequency

range

47 ~ 63 Hz

Input AC current 1.7 A at 90 VAC and maximum load

Output Output power 65W

DC output 5V/9V/12V/15V/20V Hold-up time 5ms at 115 Vac input

<8.0A

Output current limit

USB Type C

Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating -4°F to 185°F (-20°to 85°C)

(storage) temperature

Altitude 0 to 16,400 ft (0 to 5,000m)

Humidity 5% to 95% **Storage Humidity** 5% to 95%

EMI and Safety Certifications Eg:

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1,

SELV:

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC

Class B, CISPR32 Class B, CCC, NOM-001 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

RH 42Whr Long Life Polymer Fast Charge 3 cell Battery Dimensions (H x W x L)

6.2 x 76.25 x 249.50 mm (0.244 x 3.002 x 9.823 inch)

0.18 kg (0.397 lb)

Cells/Type 3cell Lithium-Ion Polymer cell / 545974

Energy

Weight

Voltage 11.4V Amp-hour capacity 3.752Ah Watt-hour capacity¹ 42.75Wh

Temperature

 Operating (Charging)
 32° to 113° F (0° to 45° C)

 Operating
 14° to 122° F (-10° to 60° C)

(Discharging)

Fuel Gauge LED N/A

Warranty

Optional Travel Battery Available No

RH 51Whr Long Life Polymer Fast Charge 3 cell Battery Dimensions (H x W x L)

6.50 x 67.80 x 254.00 mm (0.256 x 2.669 x 10 inch)

Weight 0.2025 kg (0.446 lb)

Cells/Type 3cell Lithium-Ion Polymer cell / 566075

Energy

Voltage 11.58V Amp-hour capacity 4.431Ah Watt-hour capacity 51.3Wh

Temperature

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating 14° to 122° F (-10° to 60° C)
(Discharging)

Fuel Gauge LED

N/A

Warranty

Optional Travel Battery Available No

AUDIO

HD Stereo Codec ALC3247-CG

Audio I/O Ports Headset: CTIA only and Headphone-out

Internal Speaker Amplifier ALC 3247 has Embedded Class-D 2W Stereo Amplifier

Multi-streaming Capable Playback multi-streaming can be enabled in the audio control panel to allow independent audio.

Following MSFT Behavior

Sampling DAC: 48kHz

ADC: 44.1k/48kHz

Wavetable Syntheses N/A

Analog Audio Support 3.5mm Headset: CTIA only and Headphone-out

of Channels on Line-Out N/A
Internal Speaker Yes

FINGERPRINT READER

Sensor vendor Model: Elan efsa80ST (module P1515E)

Sensor typeCapacitiveDPI resolution508 dpiScan area80*80 pixelsFalse Rejection RateFRR: ≤ 3%False Acceptance RateFAR: 1:100KMobile Voltage Operation2.7V to 3.6V

Operating Temperature $-4^{\circ}F - 175^{\circ}F (-20^{\circ} \sim +80^{\circ}C)$

Current Consumption 50mA peak

Image

Low Latency Wait For 900uA

Finger

Capture Rate 30 frame/sec ESD Resistance +15KV

Detection Matrix 80*80 pixels/ 508 dpi / 4*4mm sensor area

Technical Specifications

ENVIRONMENTAL DATA

ENVIRONMENTAL DATA					
ENVIRONMENTAL DATA Eco-Label Certifications & declarations Sustainable Impact Specifications	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: • IT ECO declaration • US ENERGY STAR® • US Federal Energy Management Program (FEMP) • EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country. • TCO Certified • China Energy Conservation Program (CECP) • China State Environmental Protection Administration (SEPA) • Taiwan Green Mark • Korea Eco-label • Japan PC Green label* • Ocean-bound plastic in Speaker • 15% post-consumer recycled plastic				
System Configuration	 15% post-consumer recycled plastic Low halogen Outside Box and corrugated cushions are 100% sustainably sourced and recyclable Recycled Plastic cushions Bulk packaging available The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook". 				
Energy Consumption (in accordance with US ENERGY STAR® test method)	US				
Normal Operation (Sort idle)	5.57 W	5.47 W	5.01 W		
Normal Operation (Long idle)	0.95 W	1.31 W	1.23 W		
Sleep	0.95 W	1.31 W	1.23 W		
Off	0.30 W	0.30 W	0.28 W		
	NOTE: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.				
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		
Normal Operation (Short idle)	19 BTU/hr	18.7 BTU/hr	17.1 BTU/hr		
Normal Operation (Long idle)	on (Long				
Sleep 3.2 BTU/hr 4.5 BTU/hr 4.2 BTU/hr 4.2 BTU/hr					
Off	·				
OII					

attained for one hour.

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is

Technical Specifications

Declared Noise Emissions		und Dawer	Cound	Processing
(in accordance with		ound Power L _{wad} , bels)	Sound Pressure	
<u> </u>	,	LWAd, DetS)	(L _{pAm} , decibels)	
ISO 7779 and ISO 9296)	2.2 13.3			
Typically Configured – Idle		2.2		
Fixed Disk – Random writes		2.7		3.3
Optical Drive – Sequential		2.9	22	2.4
reads				
Longevity and Upgrading			y extending its useful life by so	everal years. Upgradeable
		or components containe		
			the warranty period and or for	up to "5" years after the end
	of production			(2.10)
Additional Information	1	•	with the Restrictions of Hazar	dous Substances (RoHS)
		tive - 2011/65/EC.		
		· -	o comply with the Waste Elect	rical and Electronic
		oment (WEEE) Directive -		
		· · · · · · · · · · · · · · · · · · ·	with California Proposition 65	(State of California; Safe
		ing Water and Toxic Enf		
	1	·	with the IEEE 1680 (EPEAT) sta	andard at the Gold level, see
		.epeat.net		
			25 grams used in the product a	ire marked per ISO11469 and
	ISO1			
	• This	product is 93.2% recycle	-able when properly disposed	of at end of life.
Packaging Materials	External:	PAPER/Corrugated		220 g
	Internal:	PLASTIC/EPE (Expand	ed Polvethylene)	170 g
	meemat.	PLASTIC/Polyethylen		55 g
		PLASTIC/Polypropyle	<u> </u>	3 g
	The plactic p			
	The plastic packaging material contains at least 0.0% recycled content. The corrugated paper packaging materials contains at least 54.5% recycled content.			
RoHS Compliance			egulations. We were among th	-
Kons Computance	-	•	(EU) Restriction of Hazardous	-
		•	e HP GSE. HP has contributed t	
	•	_	s China, India, and Vietnam.	o the development of
	_		ilar laws play an important rol	e in promoting industry-
			cern. We have supported the ir	
			l certain phthalates—in future	
		-	-	
	pertains to electrical and electronics products. We met our voluntary objective to achieve worldwide compliance with the new EU RoHS			
	requirements for virtually all relevant products by July 2013, and we will continue to extend the			
	scope of the commitment to include further restricted substances as regulations continue to			
	evolve.			
	To obtain a co	py of the HP RoHS Comp	oliance Statement, see HP RoH	IS position statement.
Material Usage	This product of	loes not contain any of t	he following substances in exc	ess of regulatory limits
		P General Specification		
	http://www.h	p.com/hpinfo/globalciti	zenship/environment/supplych	nain/gen_specifications.html
):			
	• Asbestos			
	Certain Azo Colorants			



•	Certain Brominated Flame Retardants - m	ay not be used as flame retardants in	plastics
---	---	---------------------------------------	----------

- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Technical Specifications

HP,	Inc.	Corporate	For more information about HP's commitment to the environment:			
Enviro	nmental I	Information				
			Global Citizenship Report			
			http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html			
			Eco-label certifications			
			http://www8.hp.com/us/en/hp-information/environment/ecolabels.html			
			ISO 14001 certificates:			
			http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842			
			and			
			http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf			
footno	tes		Percentage of ocean-bound plastic contained in each component varies by product			
			Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-			
			2018 standard.			
			 External power supplies, WWAN modules, power cords, cables and peripherals excluded. 			
			 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. 			
			Plastic cushions are made from >90% recycled plastic.			

COUNTRY OF ORIGIN

China



Options and Accessories (sold separately and availability may vary by country)

DOCKING (Sold Separately)

Docking station model #1 HP Thunderbolt Dock G2

Total number of supported displays

(incl.the notebook display)

Max.resolutions supported Dual 4K @30Hz or dual 4K UHD @ 60Hz is supported

Dual 8K@ 60Hz for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode

Dock Connectors 2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode

Technical limitations Thunderbolt Hosts:

Maximum of (4) displays with maximum resolution of 5K@ 30Hz running

Thunderbolt host.

Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz

Non-Thunderbolt hosts:

The highest resolution for dual displays running a non-Thunderbolt host in

multi-function mode is

(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port

Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz +

(1) 4K UHD @ 30Hz.

Docking station model #2 HP USB-C Dock G5

Total number of supported displays

(incl.the notebook display)

Max.resolutions supported Dual 5K@ 30Hz + 1 4K UHD (multi-function mode)

3

Dock Connectors 1xHDMI, 2xDP

Technical limitations Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution

mode.

Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one

4K UHD@ 30 Hz on HDMI in Multi-function mode

The highest resolution for a non-Thunderbolt host in multi-function mode is a

single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.

Docking station model #3 HP USB-C/A Universal Dock G2

Total number of supported displays

(incl.the notebook display)
Max.resolutions supported

Triple 4K UHD@ 60Hz 3840 x 2160

Dock Connectors 1xHDMI, 2xDP

Technical limitations The best resolution for dual or triple displays is 4K UHD@ 60Hz.

For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the

host.

3



Options and Accessories (sold separately and availability may vary by country)

Category	Description	Part Number
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA
	HP Wired 3.5mm Stereo Headset	428K7AA
Cases	HP Business 14.1 Sleeve	2UW01AA
	HP Business Slim 17.3 Top Load	2UW02AA
	HP Executive 14.1 Tote	6KD10AA
	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Executive 17.3 Backpack	6KD05AA
	HP Executive 17.3 Top Load	6KD08AA
	HP Executive Leather 15.6 Top Load	6KD09AA
	HP Executive Slim 14.1 Top Load	6KD04AA
	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Renew 14 Laptop Sleeve	2E6U9AA,2E6V0AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
Docking	HP Thunderbolt 120W G2 Dock	2UK37AA
Docking	HP Thunderbolt 120W G2 Dock w/Audio	3YE87AA
	HP Thunderbolt 120W G4 Dock	4J0A2AA
	HP Thunderbolt 230W G2 Dock w/Combo Cable	3TR87AA
	HP Thunderbolt 280W G4 Dock w/Combo Cable	4J0G4AA
	HP USB-C/A 120W G2 Universal Dock	5TW13AA
	HP USB-C 120W G5 Dock	26D32AA
Hub	HP Universal USB-C Multiport Hub	50H55AA
1140	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP HDMI to DVI Adapter	F5A28AA
	HP HDMI to VGA Adapter	H4F02AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to VGA Adapter	N9K76AA
Keyborad/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
-,	HP 455 Programmable Wireless Keyboard	4R177AA



Options and Accessories (sold separately and availability may vary by country)

- p		, , , ,
	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP USB Premium Wireless Mouse	1JR31AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1D0K8AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 65W USB-C Auto Chevy AC Power Adapter	5TQ76AA
	HP 45W 4.5 mm Smart AC Power Adapter	H6Y88AA
	HP 45W USB-C G2 Zeus AC Power Adapter	1HE07AA
	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP 65W 4.5 mm LC Smart non-EM India Ony AC Power Adapter	3FF84AA#ACJ
	HP 65W 4.5 mm Smart AC Power Adapter	H6Y89AA
	HP 65W 4.5 mm wDongle 7.4 mm Slim AC Power Adapter	H6Y82AA
	HP 65W USB-C Hades AC Power Adapter	1HE08AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA



Summary of Changes

Date of change	Version History		Description of change
January 25, 2022	V1 to V2	Added	TPM, Smart reader, IPv6 Compliance and FirstNet Certified in Security section and Battery Life
February 11, 2022	V2 to V3	Updated	USB Type-C® and HDMI from Ports/Slots section
February 22, 2022	V3 to V4	Updated	Battery life and WWAN module
March 1, 2022	V4 to V5	Added	Wake on WLAN in Networking section
March 14, 2022	V5 to V6	Added	Battery Compliance in Power section
April 11, 2022	V6 to V7	Added	Reference for USB ports
May 24, 2022	V7 to V8	Added	DASH support in Networking section
June 15, 2022	V8 to V9	Added	Added note in Manageability Feature
October 19, 2022	V9 to V10	Updated	Bluetooth version
November 4, 2022	V10 to V11	Updated	Ports section
December 7, 2022	V11 to V12	Updated	Windows OS
December 19, 2022	V12 to V13	Updated	Battery life section
January 20, 2023	V13 to V14	Updated	Operating System
January 25, 2023	V14 to V15	Added	Miracast in Networking section
March 2, 2023	V15 to V16	Updated	Networking and communications section
	V16 to V17		

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